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APPLICATION NO.	FILING DATE		FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
09/678,142	10/03/2000		Noriaki Sakamoto	10417-049001	6940
7	7590	07/18/2002			
Chris T Mizu			EXAMINER		
Fish & Richard Suite 2800			NORRIS, JEREMY C		
45 Rockefeller New York, NY			ART UNIT	PAPER NUMBER	
,			2827		

Please find below and/or attached an Office communication concerning this application or proceeding.

					m.					
		Application	on No.	Applicant(s)						
	Office Action Cumment	09/678,14	12	SAKAMOTO ET AL.						
Office Action Summary				Art Unit						
		Jeremy N		2827						
	The MAILING DATE of this communication appears on the cover sheet with the correspondence address Period for Reply									
THE N - Extendent of the S - If the S - If NO - Failure - Any re	DRTENED STATUTORY PERIOD FOR MAILING DATE OF THIS COMMUNICATION of time may be available under the provisions of 37 GIX (6) MONTHS from the mailing date of this communication of the period for reply specified above is less than thirty (30) data period for reply is specified above, the maximum statutor is to reply within the set or extended period for reply will, eply received by the Office later than three months after the patent term adjustment. See 37 CFR 1.704(b).	TION. 7 CFR 1.136(a). In no everation. 19s, a reply within the state to provide will apply and we by statute, cause the app	ent, however, may a reply be tin utory minimum of thirty (30) day ill expire SIX (6) MONTHS from lication to become ABANDONE	nely filed s will be considered timely. the mailing date of this commun D (35 U.S.C. § 133).	nication.					
1)⊠	Responsive to communication(s) filed	on <u>13 December :</u>	<u> 2001</u> .							
2a)	This action is <b>FINAL</b> . 2b)		non-final.							
3) Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213. <b>Disposition of Claims</b>										
4) 🖾	Claim(s) <u>1-31</u> is/are pending in the app	lication.								
4	4a) Of the above claim(s) <u>27-31</u> is/are w	rithdrawn from cor	nsideration.							
5)🛛	Claim(s) <u>26</u> is/are allowed.									
6)⊠	Claim(s) <u>1,2,4-8,11-18,20 and 23-25</u> is/	are rejected.								
7)🖂	Claim(s) <u>3,9,10,19,21 and 22</u> is/are obj	ected to.								
8) Claim(s) are subject to restriction and/or election requirement.										
Application	on Papers									
9)🖾 🗆	The specification is objected to by the E	xaminer.								
10)🛛 🛚	The drawing(s) filed on <u>04 December 20</u>	<u>001</u> is/are: a) <mark>□</mark> ac	cepted or b)  objected	to by the Examiner.						
	Applicant may not request that any objecti									
11) 🔲 🗆	The proposed drawing correction filed or	-		oved by the Examiner.						
If approved, corrected drawings are required in reply to this Office action.										
12) The oath or declaration is objected to by the Examiner.										
_	nder 35 U.S.C. §§ 119 and 120									
13)⊠ Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).										
a)[	☑ All b) ☐ Some * c) ☐ None of:									
	1. Certified copies of the priority do	cuments have bee	en received.							
	2. Certified copies of the priority do	cuments have bee	en received in Applicat	ion No						
* 5	<ul> <li>3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).</li> <li>* See the attached detailed Office action for a list of the certified copies not received.</li> </ul>									
14) Acknowledgment is made of a claim for domestic priority under 35 U.S.C. § 119(e) (to a provisional application).										
а	) ☐ The translation of the foreign langu Acknowledgment is made of a claim for	age provisional a	pplication has been re	ceived.	,					
Attachmen	•	aomesiio priority t	ander 00 0.0.0. 33 12	o anaror 121.						
1) Notice 2) Notice	e of References Cited (PTO-892) e of Draftsperson's Patent Drawing Review (PTO nation Disclosure Statement(s) (PTO-1449) Pape			ry (PTO-413) Paper No(s) Patent Application (PTO-15						

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#### **DETAILED ACTION**

#### Election/Restrictions

Applicant's election without traverse of group I, claims 1-26 in Paper No. 5 is acknowledged.

### Specification

Applicant is reminded of the proper language and format for an abstract of the disclosure.

The abstract should be in narrative form and generally limited to a single paragraph on a separate sheet within the range of 50 to 150 words. It is important that the abstract not exceed 150 words in length since the space provided for the abstract on the computer tape used by the printer is limited. The form and legal phraseology often used in patent claims, such as "means" and "said," should be avoided. The abstract should describe the disclosure sufficiently to assist readers in deciding whether there is a need for consulting the full patent text for details.

The language should be clear and concise and should not repeat information given in the title. It should avoid using phrases which can be implied, such as, "The disclosure concerns," "The disclosure defined by this invention," "The disclosure describes," etc.

The abstract of the disclosure is objected to because of the phrase "In the present invention there is formed". Correction is required. See MPEP § 608.01(b).

### **Drawings**

The drawings are objected to because the sectional views are not properly crosshatched (see MPEP 608.02). A proposed drawing correction or corrected drawings are required in reply to the Office action to avoid abandonment of the application. The objection to the drawings will not be held in abeyance.

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# Claim Objections

Claim 19 is objected to under 37 CFR 1.75(c), as being of improper dependent form for failing to further limit the subject matter of a previous claim. Applicant is required to cancel the claim(s), or amend the claim(s) to place the claim(s) in proper dependent form, or rewrite the claim(s) in independent form. Claim 19 merely restates the limitations stated in claim 9.

### Claim Rejections - 35 USC § 112

The following is a quotation of the second paragraph of 35 U.S.C. 112:

The specification shall conclude with one or more claims particularly pointing out and distinctly claiming the subject matter which the applicant regards as his invention.

Claims 8, 11, 15, 18, and 23-25 are rejected under 35 U.S.C. 112, second paragraph, as being indefinite for failing to particularly point out and distinctly claim the subject matter which applicant regards as the invention.

Claim 8 recites the limitation "the passive element" in line 2. There is insufficient antecedent basis for this limitation in the claim.

Claim 11 recites the limitation "the conductive coating film" in line 2. There is insufficient antecedent basis for this limitation in the claim.

Claim 15 recites the limitation "the ...second pads" in line 2. There is insufficient antecedent basis for this limitation in the claim.

Claim 18 recites the limitation "the passive element" in line 2. There is insufficient antecedent basis for this limitation in the claim.

Claim 23 recites the limitation "the side surfaces" in line 2. There is insufficient antecedent basis for this limitation in the claim.

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Claim 24 recites the limitation "the conductive coating film" in line 2. There is insufficient antecedent basis for this limitation in the claim.

Claim 25 recites the limitation "the conductive coating film" in line 2. There is insufficient antecedent basis for this limitation in the claim.

# Claim Rejections - 35 USC § 102

The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.
- (e) the invention was described in a patent granted on an application for patent by another filed in the United States before the invention thereof by the applicant for patent, or on an international application by another who has fulfilled the requirements of paragraphs (1), (2), and (4) of section 371(c) of this title before the invention thereof by the applicant for patent.

The changes made to 35 U.S.C. 102(e) by the American Inventors Protection Act of 1999 (AIPA) do not apply to the examination of this application as the application being examined was not (1) filed on or after November 29, 2000, or (2) voluntarily published under 35 U.S.C. 122(b). Therefore, this application is examined under 35 U.S.C. 102(e) prior to the amendment by the AIPA (pre-AIPA 35 U.S.C. 102(e)).

Claims 1, 2, 4-6, 12, 13, 15, and 16 are rejected under 35 U.S.C. 102(b) as being anticipated by US 5,818,697, granted to Armezzani et al (hereafter Armezzani).

Armezzani discloses, referring to figure 4, a sheet-like board member (1) including a first planar surface and a second planar surface provided opposite the first surface, comprising: mask (5) which is formed on the second surface and has a

pattern corresponds to a plurality of first pads (8) formed in a semiconductor element mount region or in the vicinity of the semiconductor element mount region (see col. 2, lines 15-20) [claim 1], wherein the mask is made of photoresist (see col. 5, lines 10-40) [claim 2], wherein the mask is formed on a region corresponding to a wiring directly or integrally connected to the first pad [claim 4], wherein the first pads are bonding pads or pads on which solder balls (9) are to be fixed [claim 5], wherein a conductive coating film or a photoresist film which is substantially identical with a die pad is provided in the semiconductor element mount region [claim 6].

Additionally, Armezzani discloses a sheet-like board member (1) including a first planar surface and a second planar surface on which protuberances (8) of desired heights are formed and which is provided opposite the first planar surface, wherein the protuberances constitute a plurality of first pads in a semiconductor element mount region and the vicinity thereof [claim 12], wherein the protuberances constitute the wirings (7) integrally formed with the first pads (see figure 5) [claim 13], wherein the first pads and/or second pads are bonding pads, or pads on which solder balls or bumps are to be mounted [claim 15], wherein the protuberances constitute die pads to be provided in the semiconductor element mount region [claim 16].

Claims 1, 7, 8, 12-14, 17, 18, and 20 are rejected under 35 U.S.C. 102(e) as being anticipated by US 6,377,464, granted to Hashemi et al. (hereafter Hashemi).

Hashemi discloses, a sheet-like board member (102) including a first planar surface and a second planar surface provided opposite the first surface, comprising: mask (402) which is formed on the second surface and has a pattern corresponds to a

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plurality of first pads (116) formed in a semiconductor element mount region or in the vicinity of the semiconductor element mount region (see col. 5, lines 15-20) [claim 1], wherein a conductive coating film or photoresist film which is substantially identical with a passive element die pad (114) and/or outer lead electrode is formed on the second surface [claim 7], wherein the passive element is a chip resistor or a chip capacitor (see col. 4, line 1) [claim 8].

Additionally, Hashemi discloses a sheet-like board member (102) including a first planar surface and a second planar surface on which protuberances (116) of desired heights are formed and which is provided opposite the first planar surface, wherein the protuberances constitute a plurality of first pads in a semiconductor element mount region and the vicinity thereof [claim 12], wherein the protuberances constitute the wirings (402) integrally formed with the first pads [claim 13], wherein the protuberances constitute second pads (112) integrally formed with the wiring [claim 14], wherein the protuberances constitute passive element die pads and/or outer lead electrodes [claim 17], wherein the passive element is a chip resistor or chip capacitor [claim 18], wherein a plurality of patterns formed from the protuberances are taken as a unit, and the unit is arranged on the sheet-like board member in a matrix pattern (see figure 3), [claim 20].

## Allowable Subject Matter

Claim 26 is allowed.

Claims 3, 9, 10, 19, 21 and 22 are objected to as being dependent upon a rejected base claim, but would be allowable if rewritten in independent form including all of the limitations of the base claim and any intervening claims.

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Claims 11 and 23-25 would be allowable if rewritten to overcome the rejection(s) under 35 U.S.C. 112, second paragraph, set forth in this Office action and to include all of the limitations of the base claim and any intervening claims.

The following is a statement of reasons for the indication of allowable subject matter: Claim 3 states the limitation "wherein the mask is made of a conductive film". This limitation, in conjunction with the other claimed limitations was neither found to be disclosed in, nor suggested by the prior art. Claims 9, 19 state the limitation "wherein patterns which are substantially identical with guide pins or guide holes into which the guide pins are to be inserted are formed in mutually opposing sides of the sheet-like board member." This limitation, in conjunction with the other claimed limitations was neither found to be disclosed in, nor suggested by the prior art. Claim 10 states the limitation "wherein the sheet-like board member is made of a pressed metal." This limitation, in conjunction with the other claimed limitations was neither found to be disclosed in, nor suggested by the prior art. Claim 11 states the limitation "wherein the sheet-like board member is formed from a conductive foil, and the conductive coating film is formed from material differing from that of the conductive foil." This limitation, in conjunction with the other claimed limitations was neither found to be disclosed in, nor suggested by the prior art. Claim 21 states the limitation "wherein the sheet-like board member is made of mainly Cu, Al, an Fe-Ni alloy, a Cu-Al multilayered member, or an Al-Cu-Al multilayered member". This limitation, in conjunction with the other claimed limitations was neither found to be disclosed in, nor suggested by the prior art. Claim 22 states the limitation "wherein a conductive coating film which is formed from material Art Unit: 2827

differing from that of the protuberances is formed on the upper surfaces of the protuberances". This limitation, in conjunction with the other claimed limitations was neither found to be disclosed in, nor suggested by the prior art. Claim 23 states the limitation "wherein the side surfaces of the protuberances have an anchoring structure". This limitation, in conjunction with the other claimed limitations was neither found to be disclosed in, nor suggested by the prior art. Claim 24 states the limitation "wherein the conductive coating film constitutes an anvil shaped structure in the vicinity of the top surfaces of protuberances". This limitation, in conjunction with the other claimed limitations was neither found to be disclosed in, nor suggested by the prior art. Claim 25 states the limitation "wherein the conductive coating film is formed from Ni, Au, Ag, or Pd". This limitation, in conjunction with the other claimed limitations was neither found to be disclosed in, nor suggested by the prior art. Claim 26 states the limitation " wherein a plurality of first pads to be formed in a semiconductor element mount region or the vicinity thereof and protuberances which are to become wirings integrally formed with the first pads are formed within a region enclosed by an abutting region which is brought into contact with an upper metal mold". This limitation, in conjunction with the other claimed limitations was neither found to be disclosed in, nor suggested by the prior art.

#### Conclusion

The prior art made of record and not relied upon is considered pertinent to applicant's disclosure.

US 4,447,857 Marks et al.,

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US 5,796,590

Klein.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Jeremy Norris whose telephone number is 703-306-5737. The examiner can normally be reached on Mon.-Th., 9AM - 6:30 PM and alt. Fri. 9AM-5:30PM.

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If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, David L. Talbott can be reached on 703-305-9883. The fax phone numbers for the organization where this application or proceeding is assigned are 703-305-7724 for regular communications and 703-305-7724 for After Final communications.

Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the receptionist whose telephone number is 703-308-0956.

**JCSN** July 14, 2002

PRIMARY EXAMINER